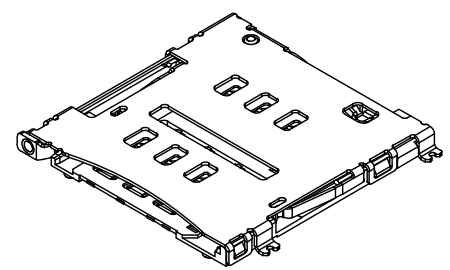


REVISIONS					
REV.	ECN NO.	LOCATION	DESCRIPTION	DATE	DESIGN
A0	N/A			2025.05.16	
A1	ECN-P-2025110809			2025.11.08	



Specification
Material:
Insulator :LCP 475 High Temperature Thermoplastic UL-94V-0
Contact:Copper Alloy C5210
Shield Shell : SUS 304
Plating:
Contact:Plsted 50u" Ni overall, Contact Au 1u"
Shield Shell : Plsted 50u" Ni overall
Plated 1u" Au Selective Contact Area
Electrical:
Current Rating :0.5A
Voltage Rating :30V AC/DC
Ambient Temperature Range:-40 ~+85
Ambient Humidity Range :95% R.H. Max.
Contact Resistance :100mΩ Max.
Insulation Resistance:1000MΩ Min./500V DC
Mating Cycles : 5000Min Insertions

WITHOUT TRAY		TRAY INSERT	
Pin No.	Description		
C1	Supply Voltage (Vcc)		
C2	Reset (RST)		
C3	Clock (CLK)		
C5	Ground		
C6	Programming Voltage (Vcc)		
C7	I/O		
SW	Detect Switch		
GND	Shielding Ground		

AuGLAR	±5°
X.	±0.40
X.x	±0.30
X.xx	±0.20
X.xxx	±0.15
UNSPECIFIED TOLERANCES	



DESIGN		VIEW:	MODEL TYPE: SIM CARD CONN
CHECKED		UNIT: mm/in	PART NO.: XKSIM-1130-1
APPROVED		SIZE: A4	DWG NO.:

SCALE	PAGE	REVISION
N/A	1/1	A2

